

MIS

TE Internal #: 92009-8

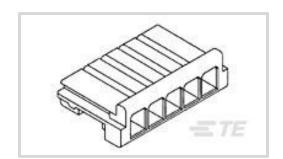
Housing, Receptacle, Wire-to-Board, 8 Position, .098 in [2.5 mm] Centerline, Crimp, 1 Row, Natural, Mating Retention, Wire & Cable,

MIS

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Connectors > PCB Connectors > Wire-to-Board Connectors > Wire-to-Board Connector Assemblies & Housings



Connector Product Type: Housing

Connector & Housing Type: Receptacle

Connector System: Wire-to-Board

Number of Positions: 8

Centerline (Pitch): 2.5 mm [.098 in]

Features

Product Type Features

Troduct Type reactives	
Connector Product Type	Housing
Connector & Housing Type	Receptacle
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Wire & Cable
Configuration Features	
Number of Positions	8
Number of Rows	1
Electrical Characteristics	
Operating Voltage	250 VAC
Body Features	
Primary Product Color	Natural
Contact Features	
Contact Type	Socket
Contact Base Material	Phosphor Bronze
Contact Current Rating (Max)	3 A

Crimp

Termination Features

Termination Method to Wire & Cable



Mechanical Attachment	
Mating Retention Type	Latch
Mating Retention	With
Connector Mounting Type	Cable Mount (Free-Hanging)
Housing Features	
Housing Material	Nylon - GF
Centerline (Pitch)	2.5 mm[.098 in]
Dimensions	
Connector Length	22.5 mm[.885 in]
Connector Height	4.5 mm[.177 in]
Wire Size	.14 – .34 mm²
Usage Conditions	
Operating Temperature Range	-25 – 105 °C[-13 – 221 °F]
Operation/Application	
Circuit Application	Power & Signal
Industry Standards	
Glow Wire Rating	Standard Part - Not Glow Wire
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	500
Packaging Method	Loose Piece

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per



homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts



Also in the Series | MIS



PCB Headers & Receptacles(23)



Wire-to-Board Connector Assemblies & Housings(25)



Wire-to-Board Connector Contacts(3)

Customers Also Bought











Documents

Product Drawings

RCPT HSG METRIC INTERCONN SYS

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_92009-8_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_92009-8_C.3d_igs.zip

English

Customer View Model

ENG_CVM_92009-8_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Application Specification

English

Crimp-Snap Metric Interconnect System

English

Agency Approvals

Agency Approval Document

English